

Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay WHITE				
2	Top Solder BLUE	Solder Resist	0.010mm	3.5	
3	Top Layer	Copper	0.035mm		
4	Dielectric1	FR-4	0.127mm	4.2	
5	Signal Layer 2	Copper	0.036mm		
6	Dielectric 3		0.600mm	4.2	
7	Signal Layer 1	Copper	0.036mm		
8	Dielectric 2		0.127mm	4.2	
9	Bottom Layer	Copper	0.035mm		
10	Bottom Solder BLUE	Solder Resist	0.010mm	3.5	
11	Bottom Overlay WHITE				

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Description	Hole Tolerance (+)	Hole Tolerance (-)
□	46	0,900mm <35,43mil>	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>			
○	80	0,300mm <11,81mil>	PTH	Round	Top Layer - Bottom Layer	<Mixed>	Rounded	<Mixed>			
	126 Total										

